

### General Description

The 150N03 is N-ch MOSFETs with extreme high cell density, which provide excellent RDS(on) and gate charge for most of the synchronous buck converter applications.

### Features

- Simple Drive Requirement
- Fast Switching
- Low On-Resistance

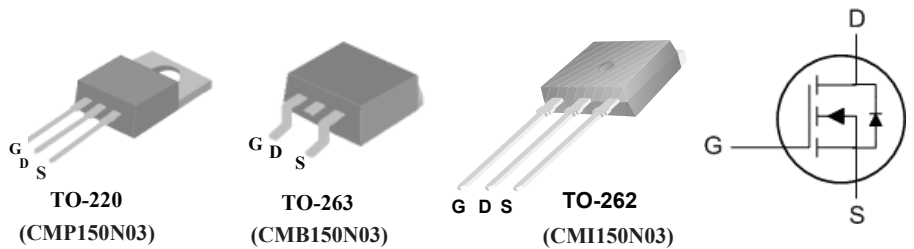
### Product Summary

BVDSS	RDS(on)	ID
30V	4.5mΩ	120A

### Applications

- HIGH CURRENT, HIGH SPEED SWITCHING
- DC-DC & DC-AC CONVERTERS
- MOTOR CONTROL, AUDIO AMPLIFIERS
- SOLENOID AND RELAY DRIVERS
- AUTOMOTIVE ENVIRONMENT

### TO220 / TO263 / TO262 Pin Configuration



### Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	30	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D@T_C=25^\circ C$	Continuous Drain Current <sup>1</sup>	120	A
$I_{DM}$	Pulsed Drain Current <sup>2</sup>	360	A
EAS	Single Pulse Avalanche Energy <sup>3</sup>	720	mJ
$P_D$	Total Power Dissipation	250	W
$T_{STG}$	Storage Temperature Range	-55 to 175	$^\circ C$
$T_J$	Operating Junction Temperature Range	-55 to 175	$^\circ C$

### Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient	---	62.5	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance Junction-case	---	0.5	$^\circ C/W$

### Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	30	---	---	V
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =50A	---	---	4.5	mΩ
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA	1	---	3	V
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V	---	---	1	uA
		V <sub>DS</sub> =30V, V <sub>GS</sub> =0V, TC=125°C	---	---	10	
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	---	---	±100	nA
g <sub>fs</sub>	Forward Transconductance <sup>4</sup>	V <sub>DS</sub> =15V, I <sub>D</sub> =50A	---	150	---	S
Q <sub>g</sub>	Total Gate Charge	I <sub>D</sub> =120A	---	95	135	nC
Q <sub>gs</sub>	Gate-Source Charge	V <sub>DD</sub> =24V	---	28	---	
Q <sub>gd</sub>	Gate-Drain Charge	V <sub>GS</sub> =10V	---	35	---	
T <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> =15V	---	30	---	ns
T <sub>r</sub>	Rise Time	I <sub>D</sub> =60A	---	208	---	
T <sub>d(off)</sub>	Turn-Off Delay Time	R <sub>G</sub> =4.7 Ω	---	82	---	
T <sub>f</sub>	Fall Time	V <sub>GS</sub> =10V	---	45	---	
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1MHz	---	4600	---	pF
C <sub>oss</sub>	Output Capacitance		---	980	---	
C <sub>rss</sub>	Reverse Transfer Capacitance		---	115	---	

### Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I <sub>S</sub>	Continuous Source Current	V <sub>G</sub> =V <sub>D</sub> =0V, Force Current	---	---	120	A
I <sub>SM</sub>	Pulsed Source Current <sup>2</sup>		---	---	360	A
V <sub>SD</sub>	Diode Forward Voltage <sup>4</sup>	V <sub>GS</sub> =0V, I <sub>S</sub> =120A	---	---	1.3	V

Note :

- 1.Current Limited by Package
- 2.Pulse width limited by safe operating area
- 3.Starting T<sub>J</sub> = 25°C, I<sub>D</sub> = 60A, V<sub>DD</sub>=30 V
- 4.Pulsed: pulse duration=300μs, duty cycle 1.5%